



February 2008

74LVX132

Low Voltage Quad 2-Input NAND Schmitt Trigger

Features

- Input voltage level translation from 5V to 3V
- Ideal for low power/low noise 3.3V applications
- Guaranteed simultaneous switching noise level and dynamic threshold performance

General Description

The LVX132 contains four 2-input NAND Schmitt Trigger Gates. The pin configuration and function are the same as the LVX00 but the inputs have hysteresis between the positive-going and negative-going input thresholds, which are capable of transforming slowly changing input signals into sharply defined, jitter-free output signals, thus providing greater noise margins than conventional gates.

The inputs tolerate voltages up to 7V allowing the interface of 5V systems to 3V systems.

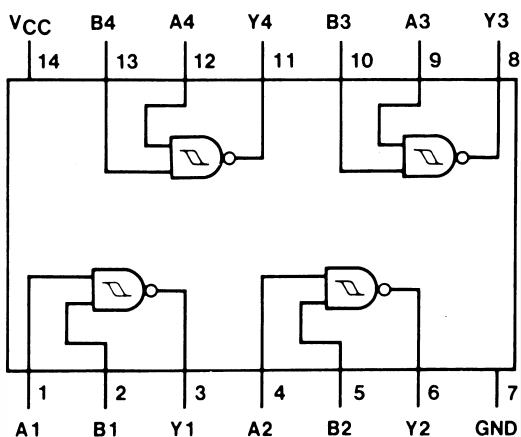
Ordering Information

| Order Number | Package Number | Package Description |
|--------------|----------------|--|
| 74LVX132M | M14A | 14-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150" Narrow |
| 74LVX132SJ | M14D | 14-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide |
| 74LVX132MTC | MTC14 | 14-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide |

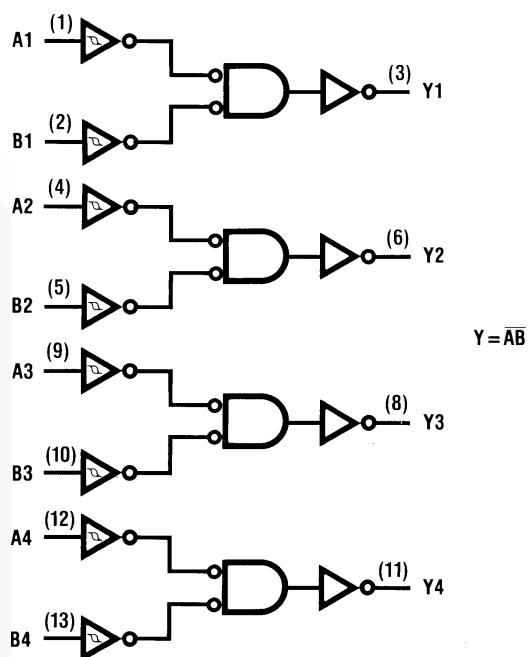
Device also available in Tape and Reel. Specify by appending suffix letter "X" to the ordering number.

 All packages are lead free per JEDEC: J-STD-020B standard.

Connection Diagram



Logic Diagram



Pin Description

| Pin Names | Descriptions |
|---------------------------------|--------------|
| A _n , B _n | Inputs |
| Y _n | Outputs |

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

| Symbol | Parameter | Rating |
|-----------------------|--|--------------------------|
| V_{CC} | Supply Voltage | -0.5V to +7.0V |
| I_{IK} | DC Input Diode Current, $V_I = -0.5V$ | -20mA |
| V_I | DC Input Voltage | -0.5V to 7V |
| I_{OK} | DC Output Diode Current $V_O = -0.5V$ | -20mA |
| | $V_O = V_{CC} + 0.5V$ | +20mA |
| V_O | DC Output Voltage | -0.5V to $V_{CC} + 0.5V$ |
| I_O | DC Output Source or Sink Current | $\pm 25mA$ |
| I_{CC} or I_{GND} | DC V_{CC} or Ground Current | $\pm 50mA$ |
| T_{STG} | Storage Temperature | -65°C to +150°C |
| P | Power Dissipation | 180mW |

Recommended Operating Conditions⁽¹⁾

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to absolute maximum ratings.

| Symbol | Parameter | Rating |
|-----------------------|--------------------------|------------------|
| V_{CC} | Supply Voltage | 2.0V to 3.6V |
| V_I | Input Voltage | 0V to 5.5V |
| V_O | Output Voltage | 0V to V_{CC} |
| T_A | Operating Temperature | -40°C to +85°C |
| $\Delta t / \Delta V$ | Input Rise and Fall Time | 0ns/V to 100ns/V |

Note:

- Unused inputs must be held HIGH or LOW. They may not float.

DC Electrical Characteristics

| Symbol | Parameter | V _{CC} (V) | Conditions | T _A = +25°C | | | T _A = -40°C to +85°C | | Units |
|-----------------|---------------------------|---------------------|--|------------------------|------|------|---------------------------------|------|-------|
| | | | | Min. | Typ. | Max. | Min. | Max. | |
| V _{t+} | Positive Threshold | 3.0 | | | | 2.2 | | 2.2 | V |
| V _{t-} | Negative Threshold | 3.0 | | 0.9 | | | 0.9 | | V |
| V _H | Hysteresis | 3.0 | | 0.3 | | 1.2 | 0.3 | 1.2 | V |
| V _{OH} | HIGH Level Output Voltage | 2.0 | V _{IN} = V _{IL} or V _{IH} , I _{OH} = -50µA | 1.9 | 2.0 | | 1.9 | | V |
| | | 3.0 | V _{IN} = V _{IL} or V _{IH} , I _{OH} = -50µA | 2.9 | 3.0 | | 2.9 | | |
| | | 3.0 | V _{IN} = V _{IL} or V _{IH} , I _{OH} = -4mA | 2.58 | | | 2.48 | | |
| V _{OL} | LOW Level Output Voltage | 2.0 | V _{IN} = V _{IL} or V _{IH} , I _{OL} = 50 µA | | 0.0 | 0.1 | | 0.1 | V |
| | | 3.0 | V _{IN} = V _{IL} or V _{IH} , I _{OL} = 50 µA | | 0.0 | 0.1 | | 0.1 | |
| | | 3.0 | V _{IN} = V _{IL} or V _{IH} , I _{OL} = 4 mA | | | 0.36 | | 0.44 | |
| I _{IN} | Input Leakage Current | 3.6 | V _{IN} = 5.5V or GND | | | ±0.1 | | ±1.0 | µA |
| I _{CC} | Quiescent Supply Current | 3.6 | V _{IN} = V _{CC} or GND | | | 2.0 | | 20 | µA |

Noise Characteristics⁽²⁾

| Symbol | Parameter | V _{CC} (V) | C _L (pF) | T _A = 25°C | | Units |
|------------------|--|---------------------|---------------------|-----------------------|-------|-------|
| | | | | Typ. | Limit | |
| V _{OLP} | Quiet Output Maximum Dynamic V _{OL} | 3.3 | 50 | 0.3 | 0.5 | V |
| V _{OLV} | Quiet Output Minimum Dynamic V _{OL} | 3.3 | 50 | -0.3 | -0.5 | V |
| V _{IHD} | Minimum HIGH Level Dynamic Input Voltage | 3.3 | 50 | | 2.0 | V |
| V _{ILD} | Maximum LOW Level Dynamic Input Voltage | 3.3 | 50 | | 0.8 | V |

Note:

2. Input t_r = t_f = 3ns

AC Electrical Characteristics

| Symbol | Parameter | V _{CC} (V) | C _L (pF) | T _A = +25°C | | | T _A = -40°C to +85°C | | Units |
|---------------------------------------|--------------------------------------|---------------------|---------------------|------------------------|------|------|---------------------------------|------|-------|
| | | | | Min. | Typ. | Max. | Min. | Max. | |
| t _{PLH} , t _{PHL} | Propagation Delay Time | 2.7 | 15 | | 7.0 | 11.5 | 1.0 | 13.0 | ns |
| | | | 50 | | 10.5 | 16.0 | 1.0 | 18.7 | |
| | | 3.3 ± 0.3 | 15 | | 6.1 | 10.6 | 1.0 | 12.5 | |
| | | | 50 | | 9.0 | 15.4 | 1.0 | 17.5 | |
| t _{OSLH} , t _{OSSH} | Output to Output Skew ⁽³⁾ | 2.7 | 50 | | | 1.5 | | 1.5 | ns |
| | | 3.3 | | | | 1.5 | | 1.5 | |

Note:

3. Parameter guaranteed by design t_{OSLH} = |t_{PLHm} - t_{PLHn}|, t_{OSSH} = |t_{PHLm} - t_{PHLn}|

Capacitance

| Symbol | Parameter | T _A = +25°C | | | T _A = -40°C to +85°C | | Units |
|-----------------|--|------------------------|------|------|---------------------------------|------|-------|
| | | Min. | Typ. | Max. | Min. | Max. | |
| C _{IN} | Input Capacitance | | 4 | 10 | | 10 | pF |
| C _{PD} | Power Dissipation Capacitance ⁽⁴⁾ | | 18 | | | | pF |

Note:

4. C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

$$\text{Average operating current can be obtained by the equation: } I_{CC(\text{opr.})} = \frac{C_{PD} \times V_{CC} \times f_{IN} \times I_{CC}}{6 \text{ (per Gate)}}$$

Physical Dimensions

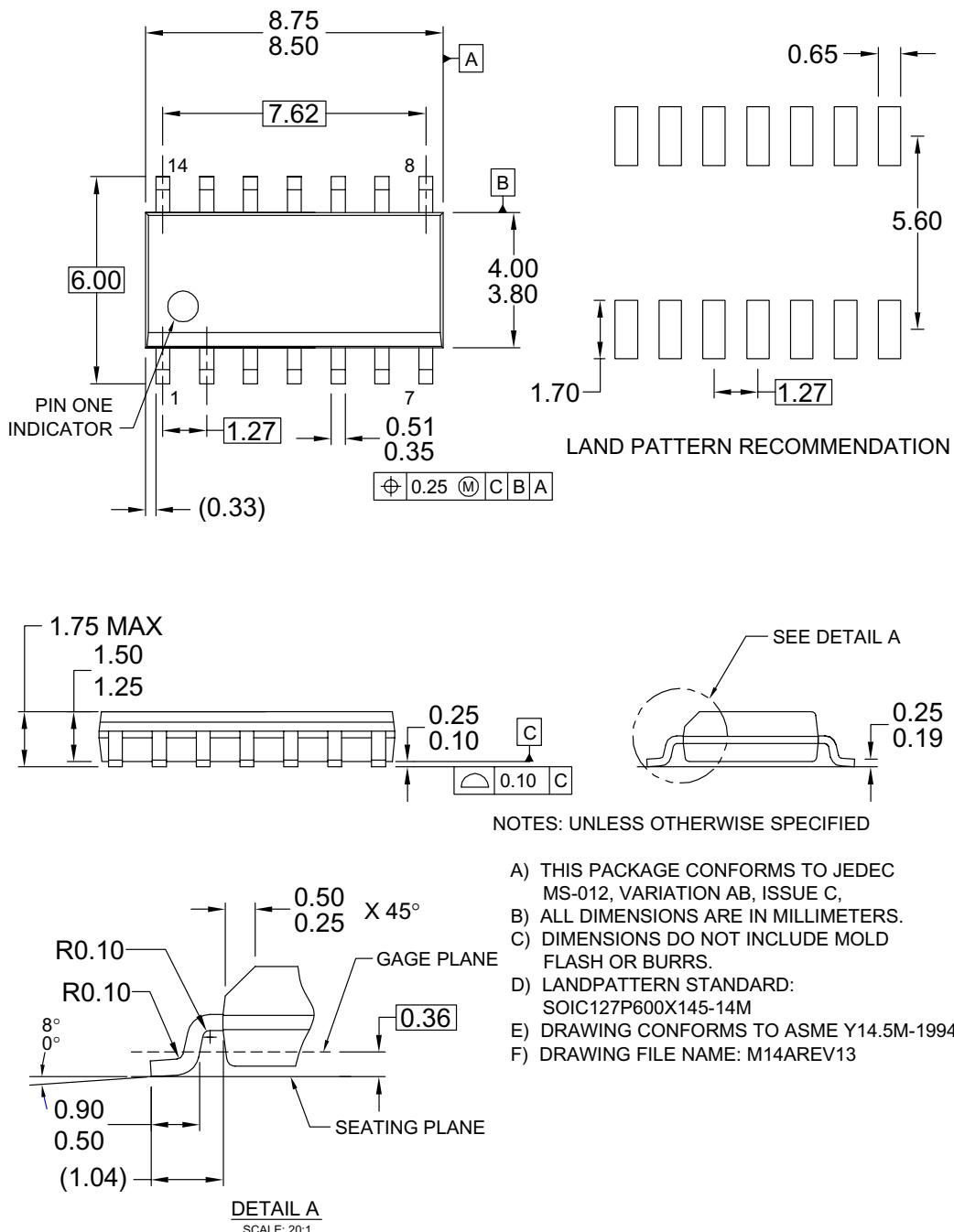


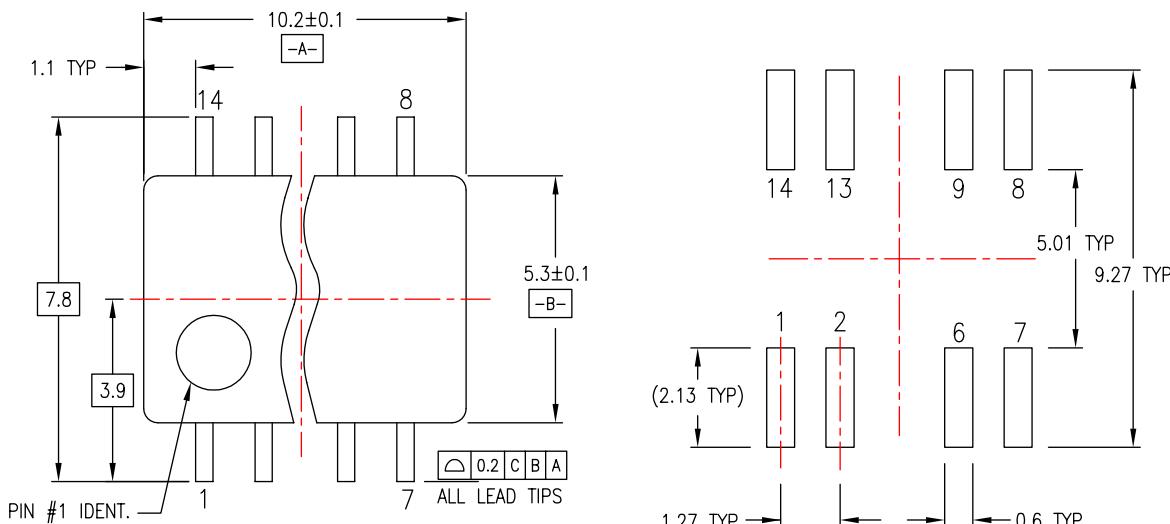
Figure 1. 14-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150" Narrow

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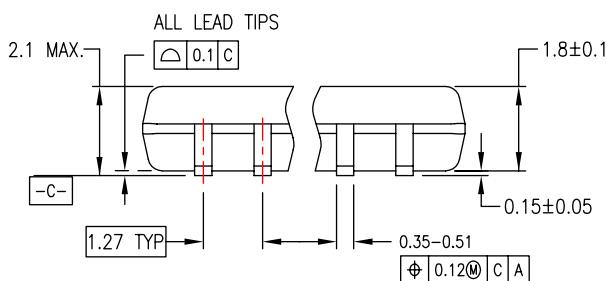
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Physical Dimensions (Continued)



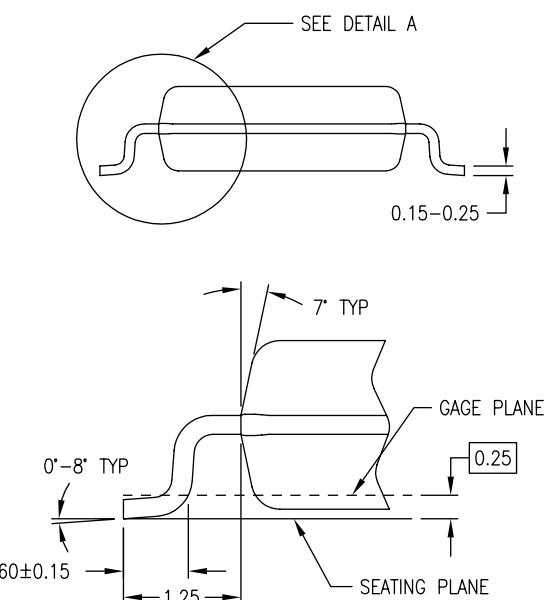
LAND PATTERN RECOMMENDATION



DIMENSIONS ARE IN MILLIMETERS

NOTES:

- A. CONFORMS TO EIAJ EDR-7320 REGISTRATION, ESTABLISHED IN DECEMBER, 1998.
- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.



DETAIL A

M14DREVC

Figure 2. 14-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide

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Physical Dimensions (Continued)

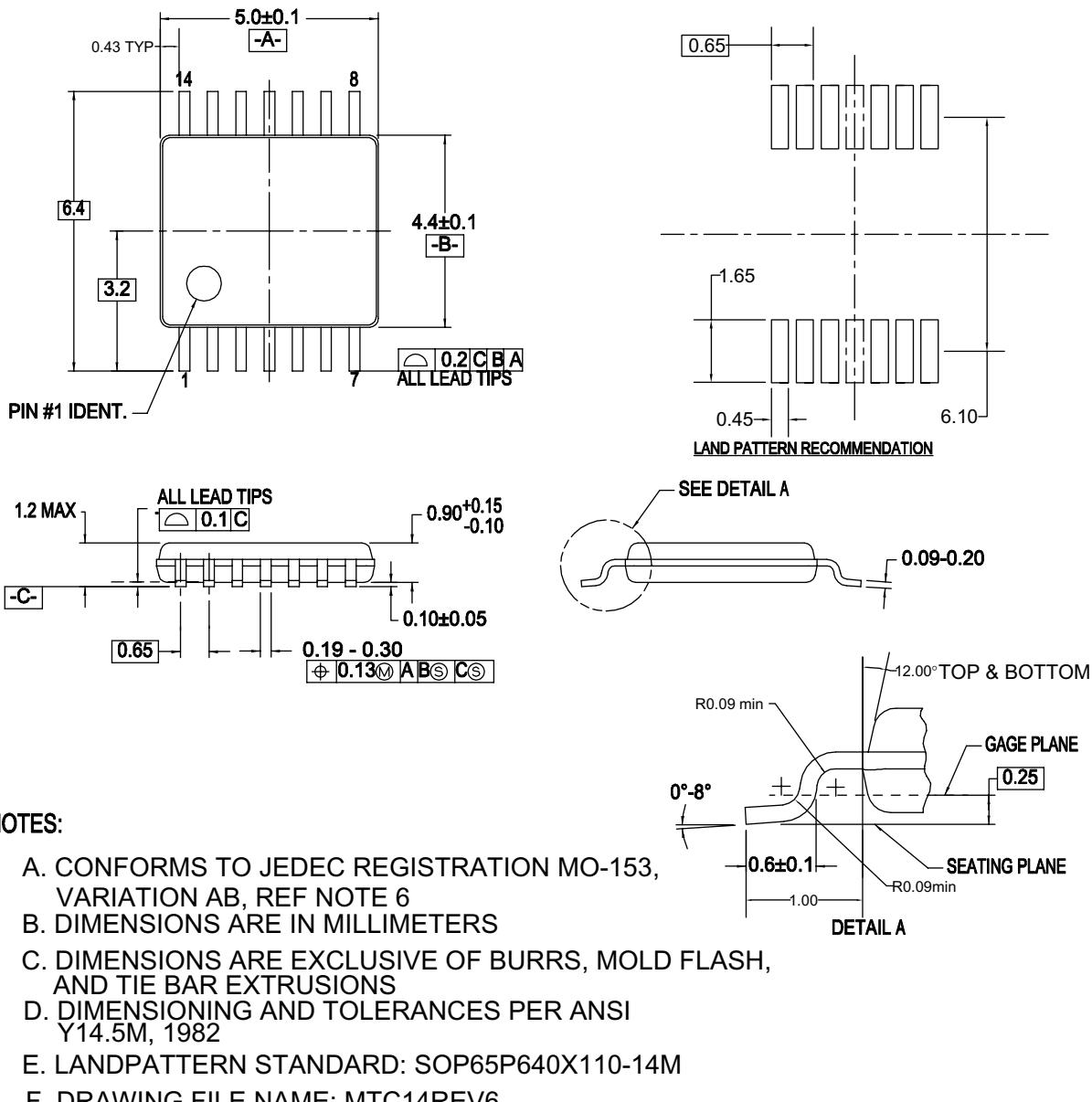


Figure 3. 14-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide

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